

MATERIAL:

INSULATOR : HIGH TEMPERATURE THERMOPLASTIC
WITH G/F ,UL 94V-0.

CONTACT : COPPER ALLOY.

CONTACT FINISH : GOLD ON MATING END,TIN ON
TERMINATION END,WITH ENTIRE
CONTACT NICKEL UNDERPLATED.

SHELL : COPPER ALLOY, NICKEL PLATED.

SPECIFICATION:

CURRENT RATING : 1 AMP.

DIELECTRIC WITHSTANDING : 100V AC.

INSULATION RESISTANCE : 100MΩ MIN.AT 100V DC.

CONTACT RESISTANCE : 50mΩ MAX.

OPERATING TEMPERATURE : 0°C ~ +50°C.

ORDER INFORMATION:

SUSBM4 - 053 - $\frac{X}{a} \frac{X}{b} - \frac{X}{c} \frac{X}{d} - \frac{X}{e}$

a. Plated selection :

- 1 : Gold 1u"
- 3 : Gold 30u"

b. Shell Plated:

- 1 : BRIGHT TIN
- 2 : MATTE TIN

c. Insulator Color :


- B : Black

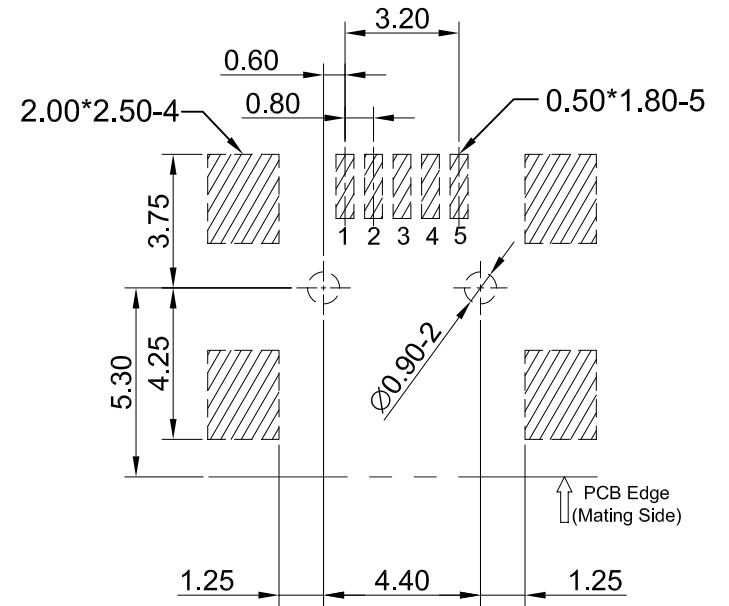
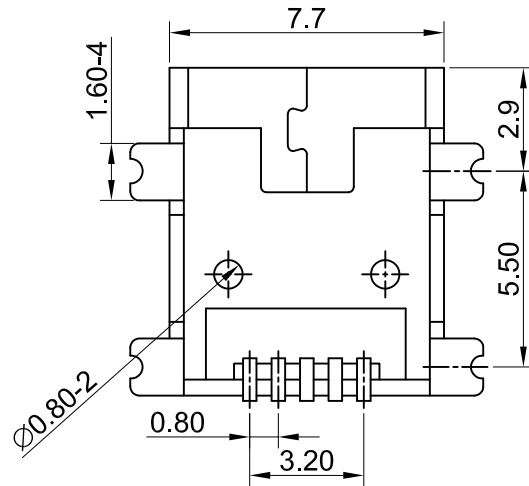
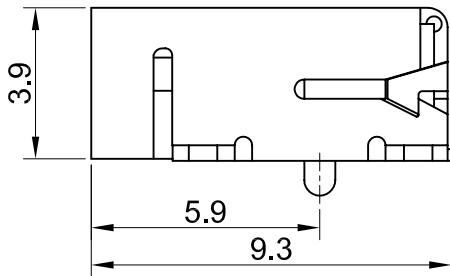
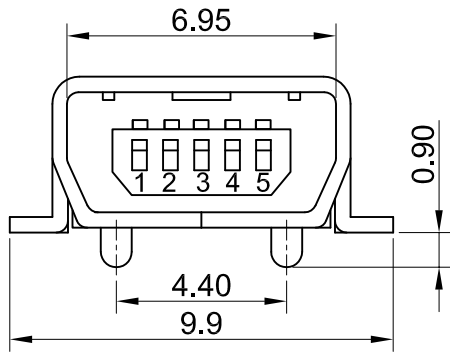
d. Insulator material :

- N : NYLON (standard)

e. Pack selection:

- R : Reel Pack

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|--|----------|------------|---|----------------------|
| GENAL TOLERANCE | DATE | H. D. LI | PART NO | SUSBM4-053-XX-XX-X |
| | DESIGN | H. D. LI | TITLE | MINI USB AB TYPE SMD |
| .X ± 0.30 .XX ± 0.20 .XXX ± 0.10 | CHECKED | Y. M. LU | | |
| UNIT :mm | APPROVED | J. F. KANG |  宏揚精密有限公司 HOJAR PRECISION CO., LTD. | |



PCB Layout
(Top View)

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|---|----------|------------|---|
| GENAL TOLERANCE .X ± 0.30 .XX ± 0.20 .XXX ± 0.10 | DATE | H. D. LI | PART NO |
| | DESIGN | H. D. LI | SUSBM4-053-XX-XX-X |
| | CHECKED | Y. M. LU | TITLE |
| | APPROVED | J. F. KANG | MINI USB AB TYPE SMD |
| UNIT :mm | | |  宏揚精密有限公司 HOJAR PRECISION CO., LTD. |